

SMBJ43A

Transient Voltage Suppressors

Pppm: 600W

IFSM: 100A

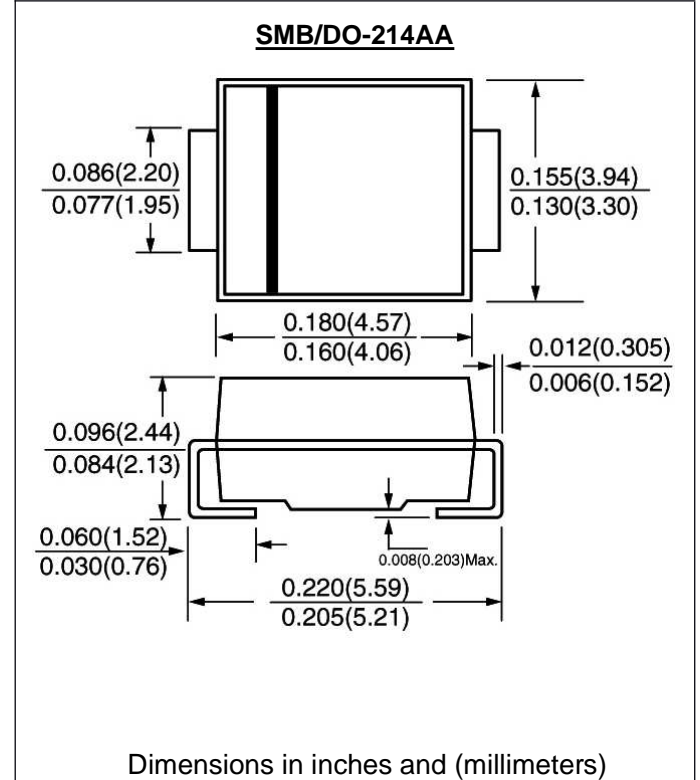


FEATURE

Low profile package
Ideal for surface mount pick and place applications
Excellent clamping capability
Very fast response time
Low incremental surge resistance
Glass passivated chip junction
High temperature soldering guaranteed
260°C/10sec/at terminals

MECHANICAL DATA

Terminal: Plated axial leads solderable per MIL-STD 202E, method 208C
Case: Molded with UL-94 Class V-0 recognized Flame Retardant Epoxy
Polarity: color band denotes cathode end
Mounting position: any



MAXIMUM RATINGS (TA = 25 °C unless otherwise noted)

Parameter	Symbol	SMBJ43A	units
Peak pulse power dissipation with a 10/1000 μ s waveform ^(1,2) (Fig. 1)	P _{PPM}	600	W
Peak pulse current with a 10/1000 μ s waveform ⁽¹⁾	I _{PPM}	7.8	A
Breakdown Voltage at I _T =1mA	V _{BR}	47.8min 58.4max	V
Maximum Reverse Leakage at V _{WM} =43V	I _R	1.0	μ A
Maximum Clamping Voltage at IPPM	V _C	76.7	V
Peak forward surge current 8.3 ms single half sine-wave uni-directional only ⁽²⁾	I _{FSM}	100	A
Maximum instantaneous forward voltage at 50A for uni-directional only	V _F	3.5	V
Typical thermal resistance, junction-to-lead	R _{th(jl)}	20	°C/W
Typical thermal resistance, junction-to--ambient	R _{th(ja)}	100	°C/W
Operating junction and Storage temperature range	T _j , T _{stg}	-55 to +150	°C

Note:
(1) Non-repetitive current pulse, per Fig. 3 and derated above TA = 25 °C per Fig. 2
(2) Mounted on 0.2x0.2" (5.0x5.0mm) copper pads to each terminal

RATINGS AND CHARACTERISTIC CURVES SMBJ43A

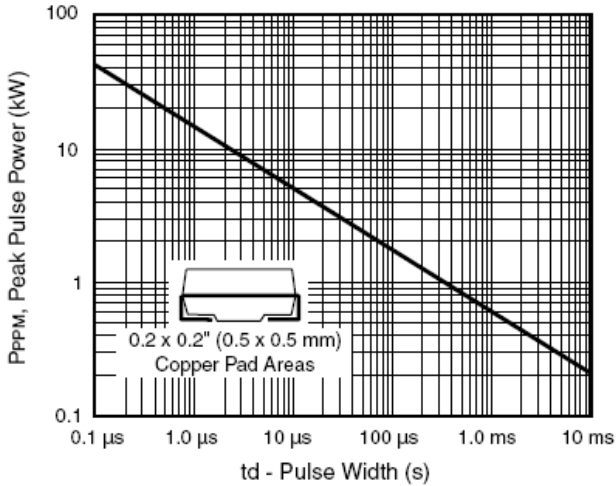


Figure 1. Peak Pulse Power Rating Curve

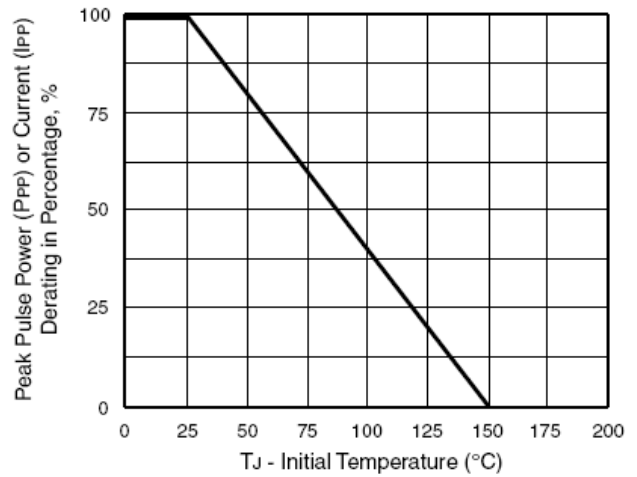


Figure 2. Pulse Power or Current versus Initial Junction Temperature

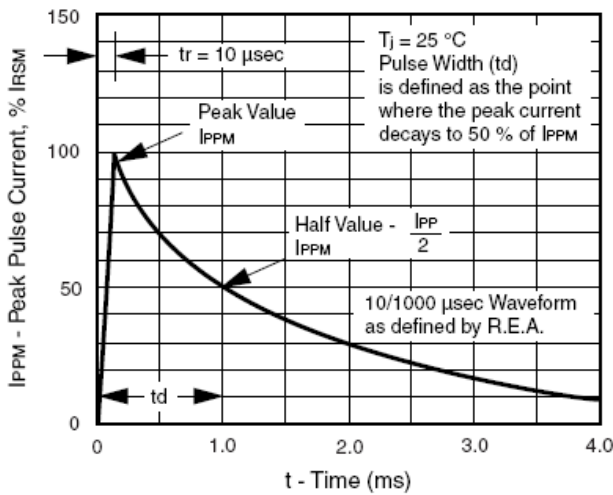


Figure 3. Pulse Waveform

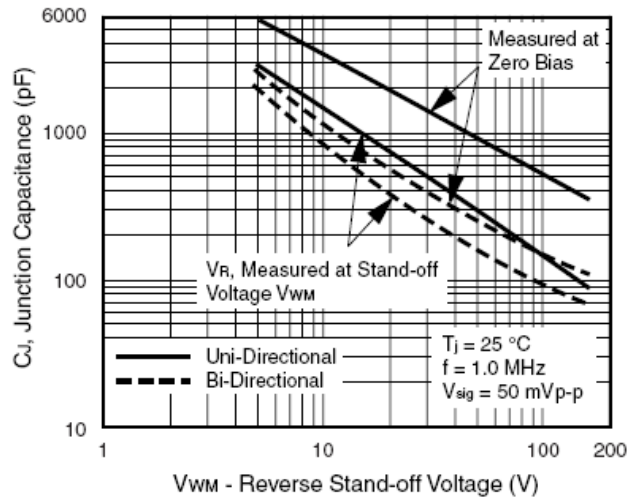


Figure 4. Typical Junction Capacitance

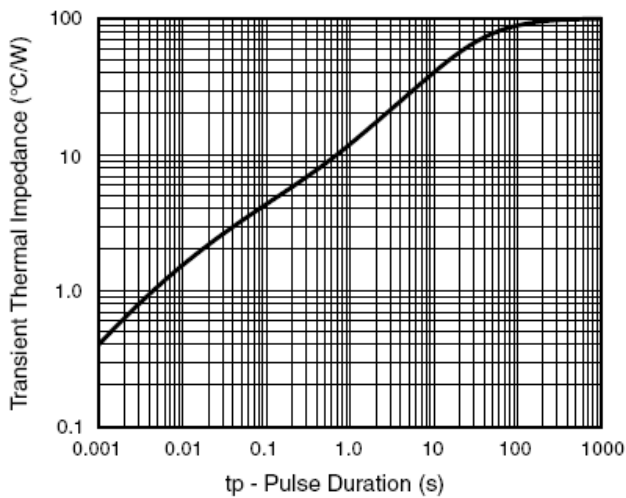


Figure 5. Typical Transient Thermal Impedance

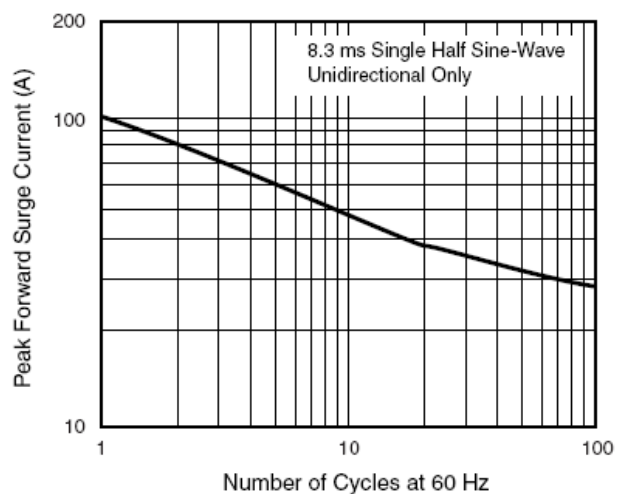


Figure 6. Maximum Non-Repetitive Peak Forward Surge Current